DC-2.7GHz, 15W, 50V GaN Fully matched PA Module

Description

The SMAV0027-15 itself is a 15-watt ,single stage integrated Power Amplifier Module, designed for broad band applications, with frequencies from 30MHz to 2.7GHz. The module is 50 Ω input/output matched and requires minimal external components.

The module implements distributed power amplifier in form of multi chips, housed in cost effective plastic open cavity package, offers a much lower cost than traditional MMIC solutions.

It is the modification of SMAV0030-15 mainly for further combination purpose to increase the broadband power. In its typical application by combining 2 pieces in parallel, it can deliver 25W CW power from HF to 2700MHz,with highly simple and compact reference design



Vds=50V, Idq=50mA, CW, ---(SMAV0027-15)*2 combination reference design

Parameter	30MHz	500MHz	1000MHz	1500MHz	2000MHz	2500MHz	2700MHz	Units
Linear Gain	16.4	15.3	15.8	15.2	15.9	15.6	14.8	dB
Gain@Pin=31dBm	13.5	13.3	13.7	13.5	13.1	13.6	13.1	dB
Pout@Pin=31dBm	28.5	26.8	29.6	28.2	25.5	29.1	25.9	W
Eff@Pin=31dBm	81	62	52	42	38	43	41	W

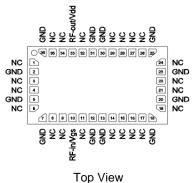
Product Features of (SMAV0027-15)*2 combination reference design

- Operating Frequency Range: 30MHz-2.7GHz
- Operating Drain Voltage: +50 V
- 50 Ω Input/Output
- Psat: ≥25W
- Small signal gain:>13dB
- Minimum efficiency:35%
- 6x10 mm Surface Mount Package for single device
- Compliant to Restriction of Hazardous Substances (RoHS) Directive 2002/95/EC

Applications

- Ultra Broadband Amplifiers
- Test Instrumentation
- EMC Amplifier Drivers
- 2-way Radios

Pin Configuration and Description



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Pin No.	Symbol			Description			
3 RFou		Transistor 1	Transistor 1, Drain Bias & RF Output				
0 RFin/Vgs		Transistor 1, RF Input &Gate Bias					
1,3,4,6,8,9,11,14-17,19,21,22,24,26- 29,32,34,35		No connecti	No connection				
2,5,7,12, 13,18,20,23,25, 30, 31,36 Package Base	GND	vias for ther	DC/RF Ground. Must be soldered to EVB ground plane over array of vias for thermal and RF performance. Solder voids under Pkg Base will result in excessive junction temperatures causing permanent damage.				
Fable 1. Maximum Ratings of single devi	ce						
Rating	Symbol		Value				
DrainSource Voltage	V _{DSS}		200				
GateSource Voltage		V _{GS}		-10 to +2			
Operating Voltage		V _{DD}		+55			
Storage Temperature Range	Tstg	-65 to +150			°C		
Case Operating Temperature	Tc	+150			°C		
Operating Junction Temperature		TJ	+225			°C	
Fable 2. Thermal Characteristics, of single	e device						
Characteristic		Symbol	Value			Unit	
Thermal Resistance, Junction to Case $T_C= 25^{\circ}C$, DC test	Rejc	6.5			°C/W		
Table 3. Electrical Characteristics of 2 pi	eces combinat	ion reference	design				
Parameter	Conditio	on	Min	Тур	Max	Unit	
Frequency Range			30		2700	MHz	
Power Gain @ Psat				13		dB	
P _{SAT}				25		W	
Drain Efficiency @ P _{SAT}			35			%	

Unless otherwise noted: TA = 25°C, V_{DD} =50 V, Pulse Width=100 us, Duty cycle=10%

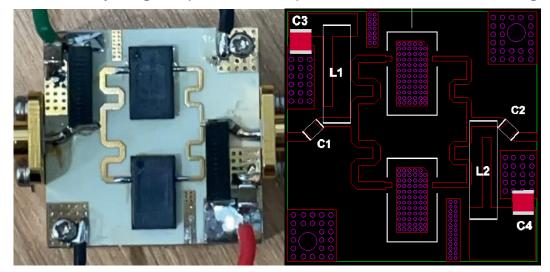
Load Mismatch of per Section (On Test Fixture, 50 ohm system): V_{DD} =50 V, I_{DQ} =25mA, f = 2.7GHz

VSWR 10:1 at P3dB pulse CW Output Power

No Device Degradation

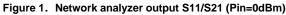
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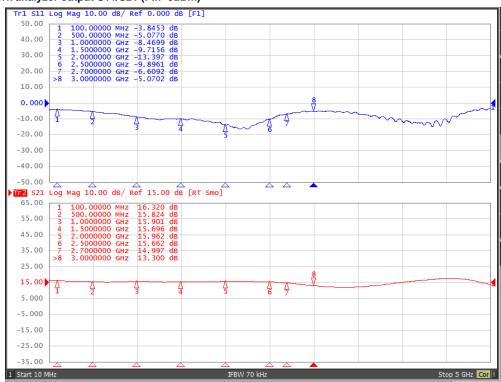
Test Fixture Assembly Diagram (SMAV0027-15)*2 combination reference design



		Part NO.	Vendor
C1, C2	50V 1uF Chip Capacitor	GRM21BR71H105KA12L	muRata
C3,C4	10uF 100V Chip Capacitor	C5750X7S2A106M230KB	TDK
L1,L2	1.3uH 4.2A Inductor	4310LC-132KEC	Coilcraft
PCB	RO4350B,20mil,er=3.48		

TYPICAL CHARACTERISTICS

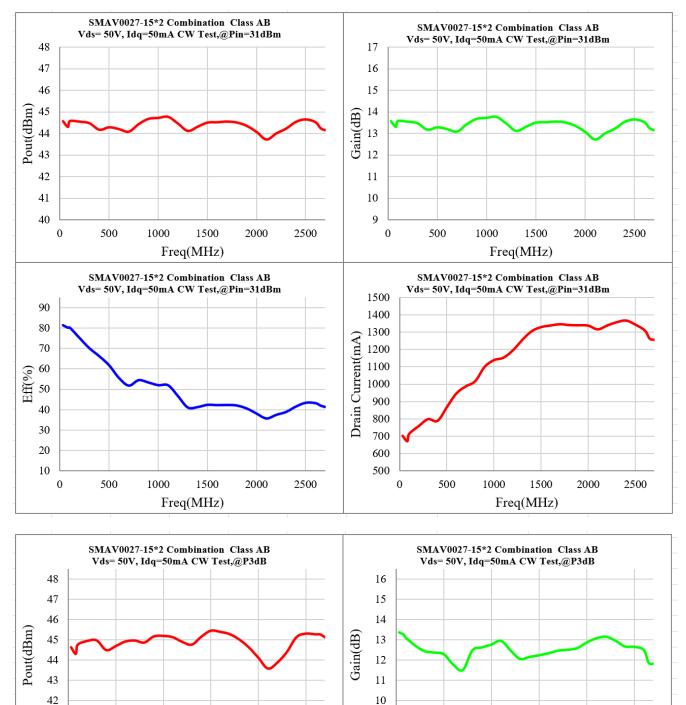




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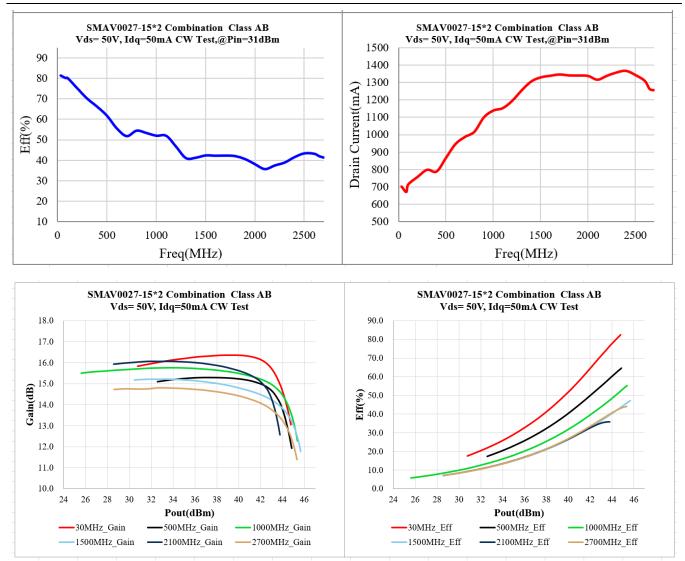
Figure 3. Pout, Power Gain and, efficiency vs. Frequency

Freq(MHz)

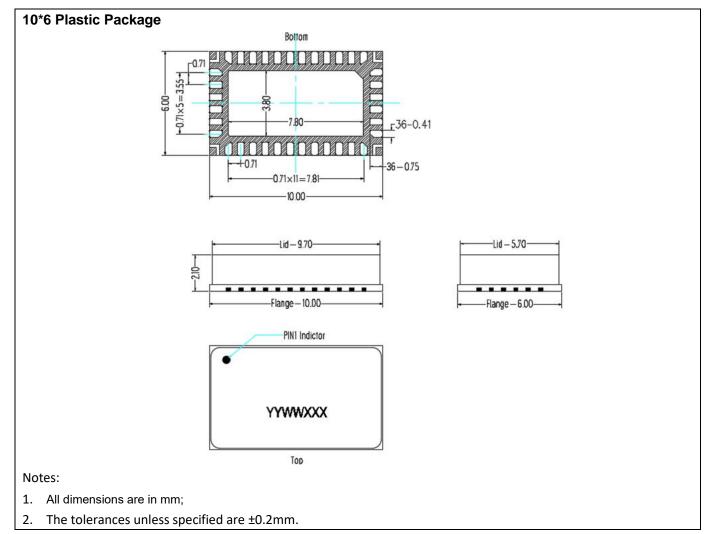


Freq(MHz)

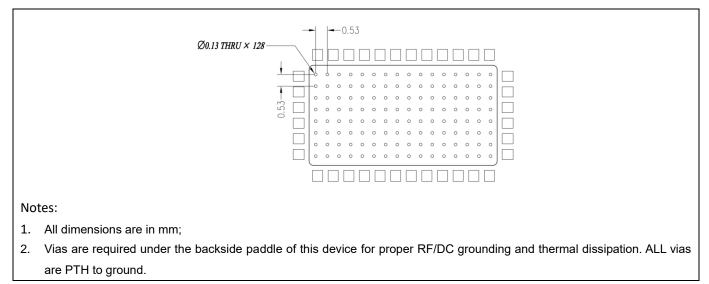
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Package Dimensions



Mounting Footprint Pattern



Revision history

Table 6. Document revision history

Date	Revision	Datasheet Status
2024/11/23	V1.0	Production datasheet

Application data based on ZHH-24-11 (2*1.2)

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